



**GP**  
**ELECTRONICS**

**GPT019N04NNCU**

**40V N-Channel MOSFET**

### Product Summary

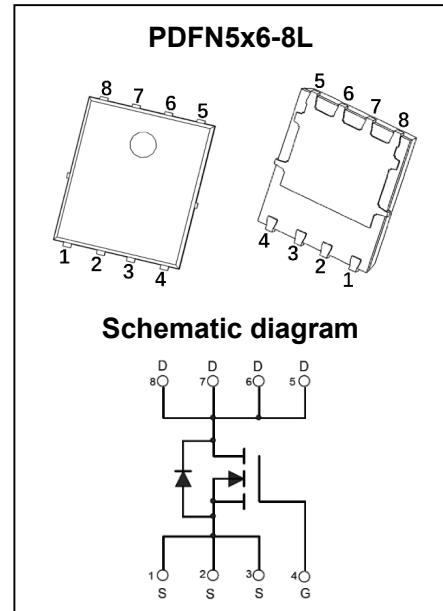
V <sub>(BR)DSS</sub>	R <sub>D(on)TYP</sub>	I <sub>D</sub>
40V	1.7mΩ@10V	130A

### Feature

- Split Gate Trench Technology
- Low R<sub>D(on)</sub>
- Low Gate Charge
- Low Gate Resistance
- 100% UIS Tested

### Application

- Power Switching Application



### MARKING:



T019N04NU = Device Code

XX = Date Code

Solid Dot = Green Indicator

### ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub> = 25°C unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain - Source Voltage	V <sub>DS</sub>	40	V
Gate - Source Voltage	V <sub>GS</sub>	±20	V
Continuous Drain Current <sup>1</sup>	T <sub>C</sub> = 25°C	I <sub>D</sub>	A
	T <sub>C</sub> = 100°C	I <sub>D</sub>	A
Pulsed Drain Current <sup>2</sup>	I <sub>DM</sub>	592	A
Single Pulsed Avalanche Current <sup>3</sup>	I <sub>AS</sub>	41	A
Single Pulsed Avalanche Energy <sup>3</sup>	E <sub>AS</sub>	340	mJ
Power Dissipation <sup>5</sup>	P <sub>D</sub>	96	W
Thermal Resistance from Junction to Ambient <sup>6</sup>	R <sub>θJA</sub>	57	°C/W
Thermal Resistance from Junction to Case	R <sub>θJC</sub>	1.3	°C/W
Junction Temperature	T <sub>J</sub>	150	°C
Storage Temperature	T <sub>STG</sub>	-55~ +150	°C

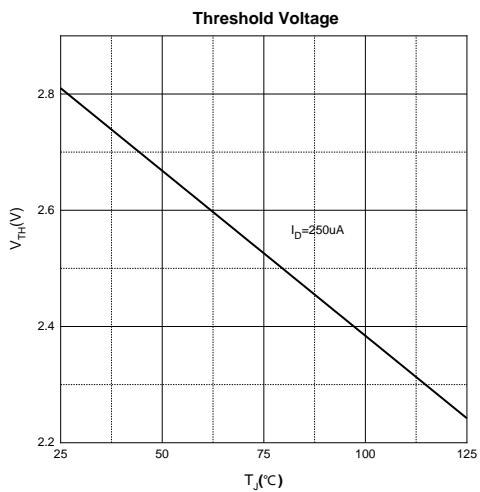
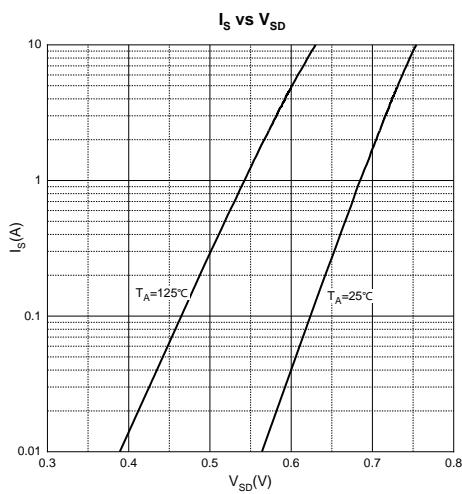
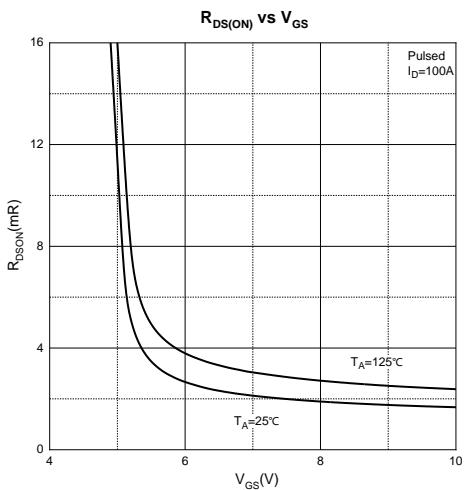
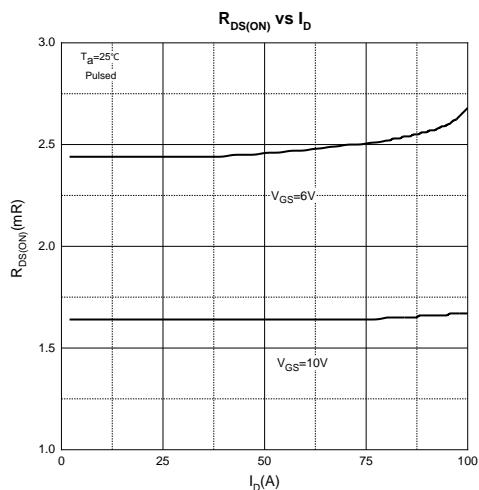
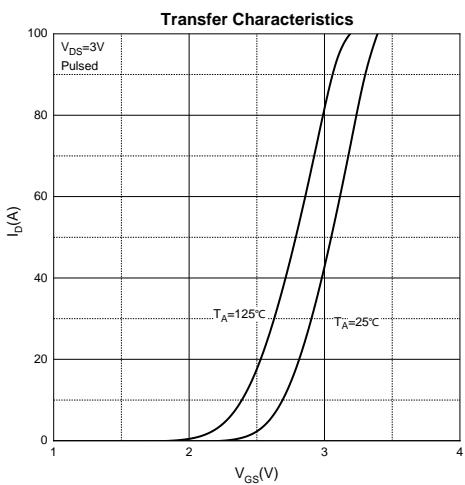
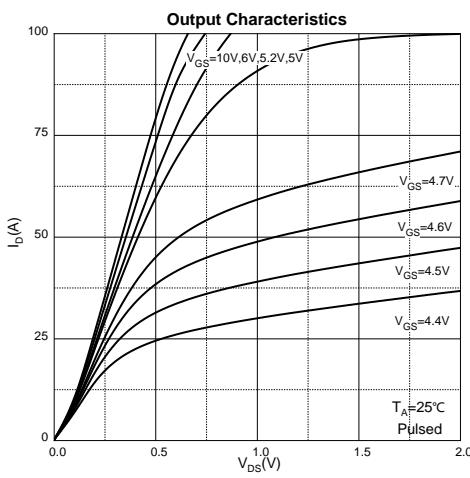
**MOSFET ELECTRICAL CHARACTERISTICS ( $T_J = 25^\circ\text{C}$  unless otherwise noted)**

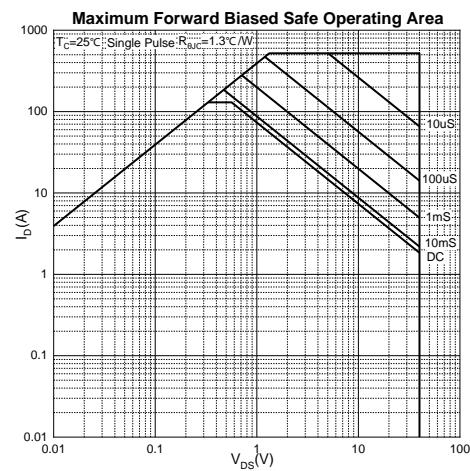
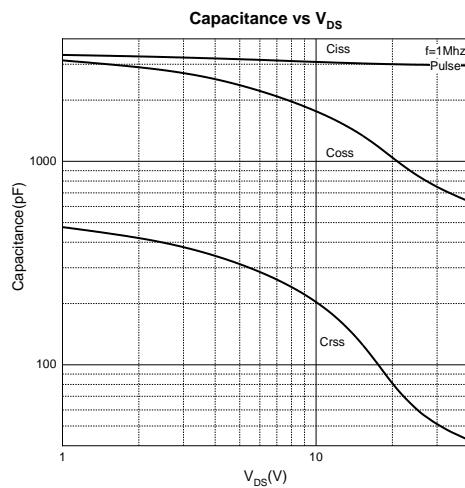
Parameter	Symbol	Test Condition	Min	Type	Max	Unit
<b>Off Characteristics</b>						
Drain - Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{\text{GS}} = 0\text{V}, I_D = 250\mu\text{A}$	40			V
Zero Gate Voltage Drain Current	$I_{\text{DSS}}$	$V_{\text{DS}} = 40\text{V}, V_{\text{GS}} = 0\text{V}$			1	$\mu\text{A}$
Gate - Body Leakage Current	$I_{\text{GSS}}$	$V_{\text{GS}} = \pm 20\text{V}, V_{\text{DS}} = 0\text{V}$			$\pm 100$	nA
<b>On Characteristics<sup>4</sup></b>						
Gate Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}} = V_{\text{GS}}, I_D = 250\mu\text{A}$	2	2.8	4	V
Drain-source On-resistance	$R_{\text{DS}(\text{on})}$	$V_{\text{GS}} = 10\text{V}, I_D = 20\text{A}$		1.7	2.2	$\text{m}\Omega$
<b>Dynamic Characteristics</b>						
Input Capacitance	$C_{\text{iss}}$	$V_{\text{DS}} = 20\text{V}, V_{\text{GS}} = 0\text{V}, f = 1\text{MHz}$		2958		pF
Output Capacitance	$C_{\text{oss}}$			1026		
Reverse Transfer Capacitance	$C_{\text{rss}}$			69		
Gate Resistance	$R_g$	$V_{\text{DS}} = 0\text{V}, V_{\text{GS}} = 0\text{V}, f = 1\text{MHz}$		4.0		$\Omega$
<b>Switching Characteristics</b>						
Total Gate Charge	$Q_g$	$V_{\text{DD}} = 20\text{V}, V_{\text{GS}} = 10\text{V}, I_D = 20\text{A}$		42		nC
Gate-source Charge	$Q_{gs}$			12		
Gate-drain Charge	$Q_{gd}$			7.2		
Turn-on Delay Time	$t_{d(\text{on})}$	$V_{\text{DD}} = 20\text{V}, V_{\text{GS}} = 10\text{V}, R_L = 1.0\Omega, R_G = 6\Omega$		10		ns
Turn-on Rise Time	$t_r$			20		
Turn-off Delay Time	$t_{d(\text{off})}$			72		
Turn-off Fall Time	$t_f$			50		
<b>Source - Drain Diode Characteristics</b>						
Diode Forward Voltage <sup>4</sup>	$V_{\text{SD}}$	$V_{\text{GS}} = 0\text{V}, I_s = 20\text{A}$			1.0	V

Notes :

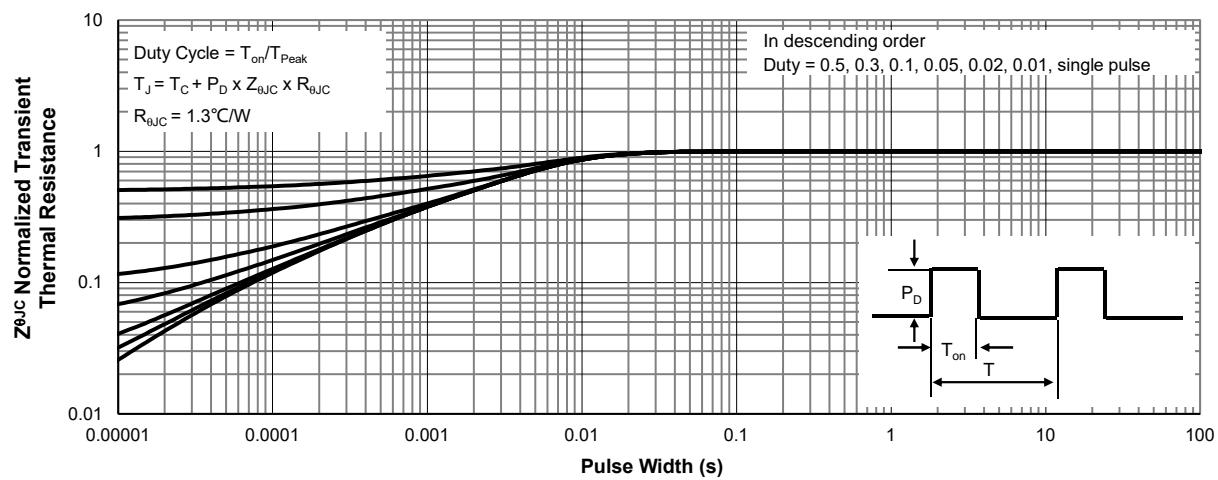
- 1.The maximum current rating is limited by package.And device mounted on a large heatsink
- 2.Pulse Test : Pulse Width  $\leq 10\mu\text{s}$ , duty cycle  $\leq 1\%$ .
- 3.EAS condition:  $V_{\text{DD}} = 20\text{V}, V_{\text{GS}} = 10\text{V}, L = 0.5\text{arting } T_J = 25^\circ\text{C}$ .
- 4.Pulse Test : Pulse Width  $\leq 300\mu\text{s}$ , duty cycle  $\leq 2\%$ .
- 5.The power dissipation  $P_D$  is limited by  $T_{J(\text{MAX})} = 150^\circ\text{C}$ .And device mounted on a large heatsink
- 6.Device mounted on 1in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A = 25^\circ\text{C}$ .

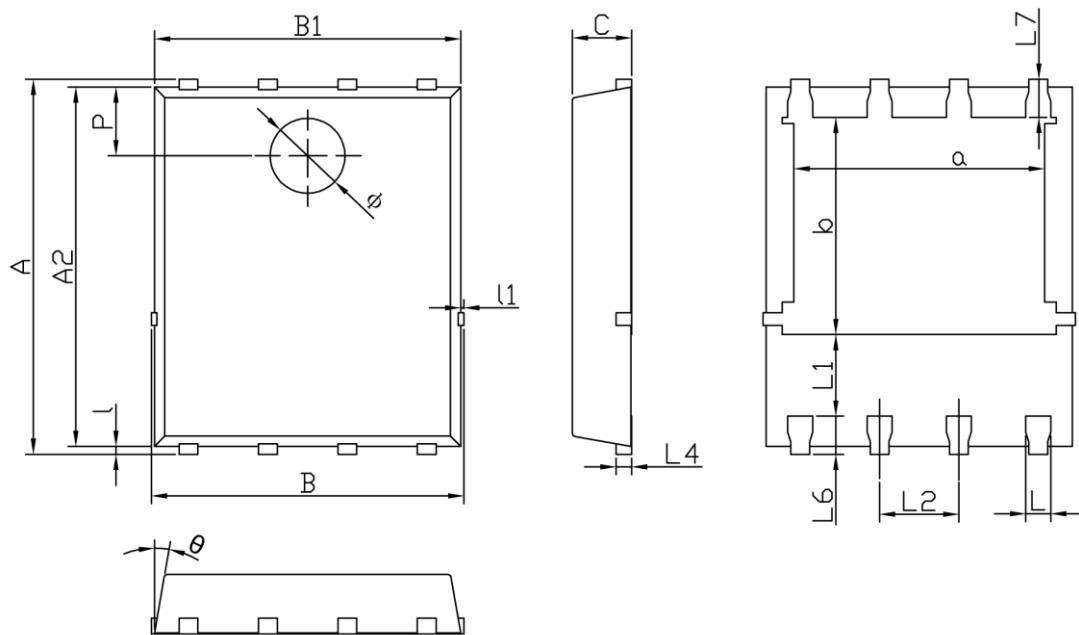
## Typical Characteristics





**Normalized Transient Thermal Impedance vs Pulse Width**



**PDFN5x6-8L Package Information**


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	5.900	6.100	0.232	0.240
a	3.910	4.110	0.154	0.162
A2	5.700	5.800	0.224	0.228
B	4.900	5.100	0.193	0.201
b	3.370	3.570	0.133	0.141
B1	4.800	5.000	0.189	0.197
C	0.900	1.000	0.035	0.039
L	0.350	0.450	0.014	0.018
I	0.060	0.200	0.002	0.008
L1	1.100	-	0.043	-
I1	-	0.100	-	0.004
L2	1.170	1.370	0.046	0.054
L4	0.210	0.340	0.008	0.013
L6	0.510	0.710	0.020	0.028
L7	0.510	0.710	0.020	0.028
P	1.000	1.200	0.039	0.047
Φ	1.100	1.300	0.043	0.051
θ	8°	12°	8°	12°